

1 M × 36-Bit Dynamic RAM Module (2 M × 18-Bit Dynamic RAM Module)

HYM 361110/20S-60/-70/-80

Advanced Information

- 1 048 576 words by 36-bit organization
(alternative 2 097 152 words by 18-bit)
- Fast access and cycle time
 - 60 ns access time
 - 110 ns cycle time (-60 version)
 - 70 ns access time
 - 130 ns cycle time (-70 version)
 - 80 ns access time
 - 150 ns cycle time (-80 version)
- Fast page mode capability with
 - 45 ns cycle time (-60/-70 version)
 - 50 ns cycle time (-80 version)
- Single + 5 V (± 10 %) supply
- Low power dissipation
 - max. 6820 mW active (-60 version)
 - max. 6160 mW active (-70 version)
 - max. 5500 mW active (-80 version)
 - CMOS – 66 mW standby
 - TTL – 132 mW standby
- $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh, $\overline{\text{RAS}}$ -only-refresh, Hidden refresh
- 12 decoupling capacitors mounted on substrate
- All inputs, outputs and clock fully TTL compatible
- 72 pin Single in-Line Memory Module
- Utilizes four 1M × 1-DRAMs and eight 1M × 4-DRAMs in 300 mil SOJ packages
- 1024 refresh cycles/16 ms
- Tin-Lead contact pads
- HYM 321110S : single sided module with 31.75 mm (1250 mil) height
- HYM 321120S : double sided module with 25.4 mm (1000 mil) height

The HYM 361110/20S-60/-70/-80 is a 36 Mbit DRAM module organized as 1 048 576 words by 36-bit in a 72-pin single-in-line package comprising four HYB 511000BJ 1 M × 1 DRAMs and eight HYB 514400BJ 1 M × 4 DRAMs in 300 mil wide SOJ-packages mounted together with twelve 0.2 μF ceramic decoupling capacitors on a PC board.

The HYM 361110/20S-60/-70/-80 can also be used as a 2 097 152 words by 18-bits dynamic RAM module by means of connecting DQ0 and DQ18, DQ1 and DQ19, DQ2 and DQ20, ..., DQ17 and DQ35, respectively.

Each HYB 511000BJ and HYB 514400BJ is described in the data sheet and is fully electrically tested and processed according to Siemens standard quality procedure prior to module assembly. After assembly onto the board, a further set of electrical tests is performed.

The speed of the module can be detected by the use of four presence detect pins.

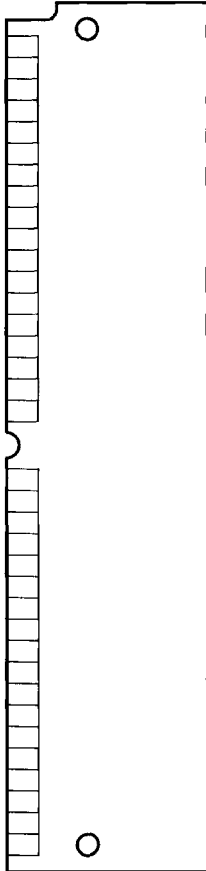
The common I/O feature on the HYM 361110/20S-60/-70/-80 dictates the use of early write cycles.

Ordering Information

Type	Ordering Code	Package	Descriptions
HYM 361110S-60	on request	L-SIM-72-5	DRAM module (access time 60 ns)
HYM 361110S-70	Q67100-Q739	L-SIM-72-5	DRAM module (access time 70 ns)
HYM 361110S-80	Q67100-Q740	L-SIM-72-5	DRAM module (access time 80 ns)
HYM 361120S-60	on request	L-SIM-72-3	DRAM module (access time 60 ns)
HYM 361120S-70	Q67100-Q741	L-SIM-72-3	DRAM module (access time 70 ns)
HYM 361120S-80	Q67100-Q742	L-SIM-72-3	DRAM module (access time 80 ns)

V_{SS} 1 DQ0 2
 DQ18 3 DQ1 4
 DQ19 5 DQ2 6
 DQ20 7 DQ3 8
 DQ21 9 V_{CC} 10
 N.C. 11 A0 12
 A1 13 A2 14
 A3 15 A4 16
 A5 17 A6 18
 N.C. 19 DQ4 20
 DQ22 21 DQ5 22
 DQ23 23 DQ6 24
 DQ24 25 DQ7 26
 DQ25 27 A7 28
 N.C. 29 V_{CC} 30
 A8 31 A9 32
 N.C. 33 RAS_2 34
 DQ26 35 DQ8 36

DQ17 37 DQ35 38
 V_{SS} 39 CAS_0 40
 CAS_2 41 CAS_3 42
 CAS_1 43 RAS_0 44
 N.C. 45 N.C. 46
 WE 47 N.C. 48
 DQ9 49 DQ27 50
 DQ10 51 DQ28 52
 DQ11 53 DQ29 54
 DQ12 55 DQ30 56
 DQ13 57 DQ31 58
 V_{CC} 59 DQ32 60
 DQ14 61 DQ33 62
 DQ15 63 DQ34 64
 DQ16 65 N.C. 66
 PD0 67 PD1 68
 PD2 69 PD3 70
 N.C. 71 V_{SS} 72



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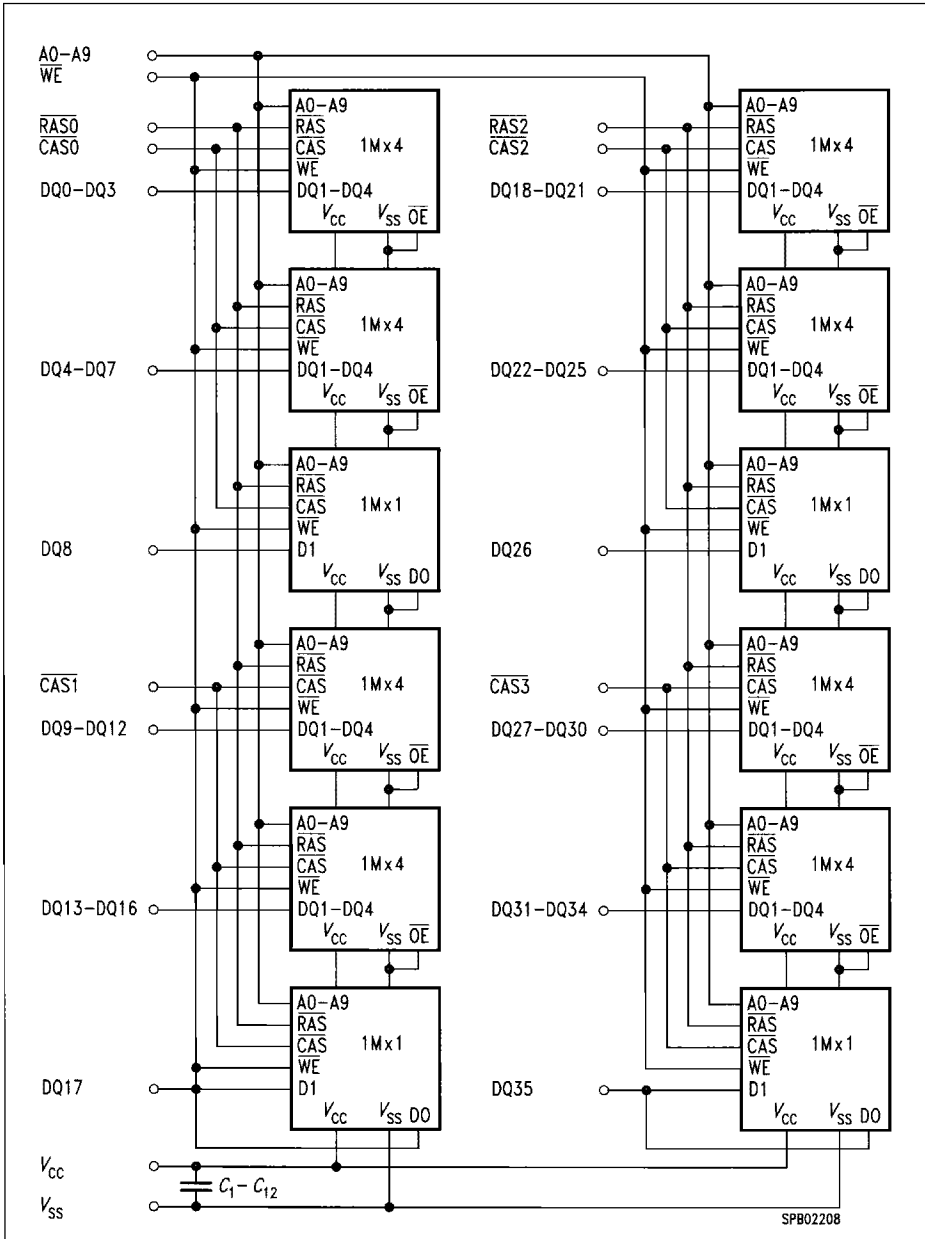
Pin Names

A0-A9	Address Inputs
DQ0-DQ35	Data Input/Output
CAS_0 - CAS_3	Column Address Strobe
RAS_0 , RAS_2	Row Address Strobe
WE	Read/Write Input
V_{CC}	Power (+ 5 V)
V_{SS}	Ground
PD	Presence Detect Pin
N.C.	No Connection

Presence Detect Pins

	-60	-70	-80
PD0	V_{SS}	V_{SS}	V_{SS}
PD1	V_{SS}	V_{SS}	V_{SS}
PD2	N.C.	V_{SS}	N.C.
PD3	N.C.	N.C.	V_{SS}

Pin Configuration



Block Diagram

Absolute Maximum Ratings

Operating temperature range	0 to + 70 °C
Storage temperature range	– 55 to + 125 °C
Soldering temperature	260 °C
Soldering time	10 s
Input/output voltage	– 1 to + 7 V
Power supply voltage	– 1 to + 7 V
Power dissipation	8.68 W
Data out current (short circuit)	50 mA

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Characteristics ¹⁾

$T_A = 0$ to 70 °C; $V_{CC} = 5$ V ± 10 %

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Input high voltage	V_{IH}	2.4	5.5	V	–
Input low voltage	V_{IL}	– 1.0	0.8	V	–
Output high voltage ($I_{OUT} = -5$ mA)	V_{OH}	2.4	–	V	–
Output low voltage ($I_{OUT} = 4.2$ mA)	V_{OL}	–	0.4	V	–
Input leakage current (0 V < V_{IN} < 6.5 V, all other pins = 0 V)	$I_{I(L)}$	– 20	20	μA	–
Output leakage current (DO is disabled, 0 V < V_{OUT} < 5.5 V)	$I_{O(L)}$	– 10	10	μA	–
Average V_{CC} supply current: HYM 361110/20S-60 HYM 361110/20S-70 HYM 361110/20S-80 (\overline{RAS} , \overline{CAS} , address cycling, $t_{RC} = t_{RC}$ min.)	I_{CC1}	–	1240 1120 1000	mA mA mA	2), 3)
Standby V_{CC} supply current ($\overline{RAS} = \overline{CAS} = V_{IH}$)	I_{CC2}	–	24	mA	–
Average V_{CC} supply current during \overline{RAS} only refresh cycles: HYM 361110/20S-60 HYM 361110/20S-70 HYM 361110/20S-80 (\overline{RAS} cycling, $\overline{CAS} = V_{IH}$, $t_{RC} = t_{RC}$ min.)	I_{CC3}	–	1240 1120 1000	mA mA mA	2)

Notes see page 379.

DC Characteristics (cont'd) ¹⁾

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Average V_{CC} supply current during fast page mode: <div style="margin-left: 20px;">HYM 361110/20S-60</div> <div style="margin-left: 20px;">HYM 361110/20S-70</div> <div style="margin-left: 20px;">HYM 361110/20S-80</div> $(\overline{RAS} = V_{IL}, \overline{CAS}, \text{address cycling})$ $t_{PC} = t_{PC \text{ min.}}$	I_{CC4}	– – –	840 720 600	mA mA mA	2), 3)
Standby V_{CC} supply current $(\overline{RAS} = \overline{CAS} = V_{CC} - 0.2 \text{ V})$	I_{CC5}	–	12	mA	–
Average V_{CC} supply current during \overline{CAS} -before- \overline{RAS} refresh mode: <div style="margin-left: 20px;">HYM 361110/20S-60</div> <div style="margin-left: 20px;">HYM 361110/20S-70</div> <div style="margin-left: 20px;">HYM 361110/20S-80</div> $(\overline{RAS}, \overline{CAS} \text{ cycling, } t_{RC} = t_{RC \text{ min.}})$	I_{CC6}	– – –	1240 1120 1000	mA mA mA	1)

Notes see page 379.

Capacitance

$T_A = 0 \text{ to } 70 \text{ }^\circ\text{C}$; $V_{CC} = 5 \text{ V} \pm 10 \%$; $f = 1 \text{ MHz}$

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Input capacitance (A0 to A9)	C_{11}	–	80	pF
Input capacitance ($\overline{RAS0}, \overline{RAS2}$)	C_{12}	–	42	pF
Input capacitance ($\overline{CAS0}$ - $\overline{CAS3}$)	C_{13}	–	35	pF
Input capacitance (\overline{WE})	C_{14}	–	80	pF
I/O capacitance (DQ0-DQ7, DQ9-DQ16, DQ18-DQ25, DQ27-DQ34)	C_{101}	–	15	pF
I/O capacitance (DQ8, DQ17, DQ26, DQ35)	C_{102}	–	20	pF

AC Characteristics ^{4) 5)}

$T_A = 0$ to 70 °C; $V_{CC} = 5$ V ± 10 %; $t_T = 5$ ns

Parameter	Symbol	Limit Values						Unit
		-60		-70		-80		
		min.	max.	min.	max.	min.	max.	
Random read or write cycle time	t_{RC}	110	–	130	–	150	–	ns
Fast page mode cycle time	t_{PC}	45	–	45	–	50	–	ns
Access time from \overline{RAS} ^{6) 11) 12)}	t_{RAC}	–	60	–	70	–	80	ns
Access time from \overline{CAS} ^{6) 11)}	t_{CAC}	–	20	–	20	–	20	ns
Access time from column address ^{6) 12)}	t_{AA}	–	30	–	35	–	40	ns
Access time from \overline{CAS} precharge ⁶⁾	t_{CPA}	–	40	–	40	–	45	ns
\overline{CAS} to output in low-Z ⁶⁾	t_{CLZ}	0	–	0	–	0	–	ns
Output buffer turn-off delay ⁷⁾	t_{OFF}	0	20	0	20	0	20	ns
Transition time (rise and fall) ⁵⁾	t_T	3	50	3	50	3	50	ns
\overline{RAS} precharge time	t_{RP}	40	–	50	–	60	–	ns
\overline{RAS} pulse width	t_{RAS}	60	10000	70	10000	80	10000	ns
\overline{RAS} pulse width (fast page mode)	t_{RASP}	60	200000	70	200000	80	200000	ns
\overline{RAS} hold time	t_{RSH}	20	–	20	–	20	–	ns
\overline{CAS} hold time	t_{CSH}	60	–	70	–	80	–	ns
\overline{CAS} pulse width	t_{CAS}	20	10000	20	10000	20	10000	ns
\overline{RAS} to \overline{CAS} delay time ¹¹⁾	t_{RCD}	20	40	20	50	20	60	ns
\overline{RAS} to column address delay time ¹²⁾	t_{RAD}	15	30	15	35	15	40	ns
\overline{CAS} to \overline{RAS} precharge time	t_{CRP}	5	–	5	–	5	–	ns
\overline{CAS} precharge time (fast page mode)	t_{CP}	10	–	10	–	10	–	ns
Row address setup time	t_{ASR}	0	–	0	–	0	–	ns
Row address hold time	t_{RAH}	10	–	10	–	10	–	ns
Column address setup time	t_{ASC}	0	–	0	–	0	–	ns
Column address hold time	t_{CAH}	15	–	15	–	15	–	ns

Notes see page 379.

AC Characteristics (cont'd) ^{4) 5)}

$T_A = 0$ to 70 °C; $V_{CC} = 5 V \pm 10 \%$; $t_T = 5$ ns

Parameter	Symbol	Limit Values						Unit
		-60		-70		-80		
		min.	max.	min.	max.	min.	max.	
Column address hold time ref. to $\overline{\text{RAS}}$	t_{AR}	50	–	55	–	60	–	ns
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	–	35	–	40	–	ns
Read command setup time	t_{RCS}	0	–	0	–	0	–	ns
Read command hold time ⁸⁾	t_{RCH}	0	–	0	–	0	–	ns
Read command hold time ref. to $\overline{\text{RAS}}$ ⁸⁾	t_{RRH}	0	–	0	–	0	–	ns
Write command hold time	t_{WCH}	10	–	15	–	15	–	ns
Write command hold time ref. to $\overline{\text{RAS}}$	t_{WCR}	45	–	55	–	60	–	ns
Write command pulse width	t_{WP}	10	–	15	–	15	–	ns
Write command to $\overline{\text{RAS}}$ lead time	t_{RWL}	20	–	20	–	20	–	ns
Write command to $\overline{\text{CAS}}$ lead time	t_{CWL}	20	–	20	–	20	–	ns
Data setup time ⁹⁾	t_{DS}	0	–	0	–	0	–	ns
Data hold time ⁹⁾	t_{DH}	15	–	15	–	15	–	ns
Data hold time ref. to $\overline{\text{RAS}}$	t_{DHR}	50	–	55	–	60	–	ns
Refresh period	t_{REF}	–	16	–	16	–	16	ms
Write command setup time ¹⁰⁾	t_{WCS}	0	–	0	–	0	–	ns
$\overline{\text{CAS}}$ setup time ¹³⁾	t_{CSR}	5	–	5	–	5	–	ns
$\overline{\text{CAS}}$ hold time ¹³⁾	t_{CHR}	15	–	15	–	15	–	ns
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ precharge time	t_{RPC}	0	–	0	–	0	–	ns
$\overline{\text{CAS}}$ precharge time ¹³⁾	t_{CPN}	10	–	10	–	10	–	ns
Write to $\overline{\text{RAS}}$ precharge time ¹³⁾	t_{WRP}	10	–	10	–	10	–	ns
Write to time ref. to $\overline{\text{RAS}}$ ¹³⁾	t_{WRH}	10	–	10	–	10	–	ns

Notes see page 379.

Waveforms see page 399.

Notes for pages 375 to 378:

- 1) All voltages are referenced to V_{SS} .
- 2) I_{CC1} , I_{CC3} , I_{CC4} and I_{CC6} depend on cycle rate.
- 3) I_{CC1} and I_{CC4} depend on output loading. Specified values are measured with the output open.
- 4) An initial pause of 200 μ s is required after power-up followed by 8 $\overline{\text{RAS}}$ cycles out of which at least one cycle has to be a refresh cycle before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ initialization cycles instead of 8 $\overline{\text{RAS}}$ cycles are required.
- 5) V_{IH} (min.) and V_{IL} (max.) are reference levels for measuring timing of input signals. Transition times are also measured between V_{IH} and V_{IL} .
- 6) Measured with a load equivalent of 2 TTL loads and 100 pF.
- 7) t_{OFF} (max.) defines the time at which the output achieves the open-circuit condition and is not referenced to output voltage levels.
- 8) Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
- 9) These parameters are referenced to the $\overline{\text{CAS}}$ leading edge.
- 10) t_{WCS} is not a restrictive operating parameter. This is included in the data sheet as electrical characteristic only. If $t_{WCS} > t_{WCS}(\text{min.})$, the cycle is an early write cycle and data out pin will remain open circuit (high impedance).
- 11) Operation within the $t_{RCD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RCD}(\text{max.})$ is specified as a reference point only. If t_{RCD} is greater than the specified $t_{RCD}(\text{max.})$ limit, then access time is controlled by t_{CAC} .
- 12) Operation within the $t_{RAD}(\text{max.})$ limit insures that $t_{RAC}(\text{max.})$ can be met. $t_{RAD}(\text{max.})$ is specified as a reference point only. If t_{RAD} is greater than the specified $t_{RAD}(\text{max.})$ limit, then access time is controlled by t_{AA} .
- 13) For $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ cycles only.

